

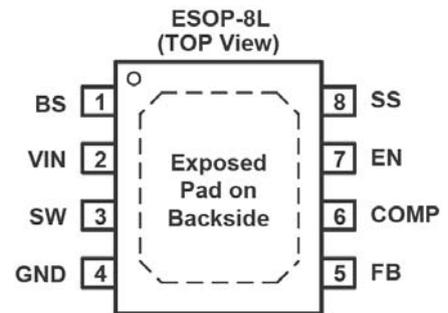
3A, 27V, 340 kHz Synchronous Rectified Step-Down

- Features**

- 3A Output Current
- Wide 4.5V to 27V Operating Input Range
- Fixed 340KHZ Frequency
- Integrated Power MOSFET switches
- Output Adjustable from 0.925V to 0.8Vin
- Up to 93% Efficiency
- Programmable Soft-Start
- Stable with Low ESR Ceramic Output Capacitors
- Cycle by Cycle Over Current Protection
- Short Circuit Protection
- Input Under Voltage Lockout
- Package: ESOP-8L

- General Description**

The FS1068E is a monolithic synchronous buck regulator. The device integrates 90 mΩ MOSFETS that provide 3A continuous load current over a wide operating input voltage of 4.5V to 27V. Current mode control provides fast transient response and cycle by cycle current limit. An adjustable soft-start prevents inrush current at turn on.

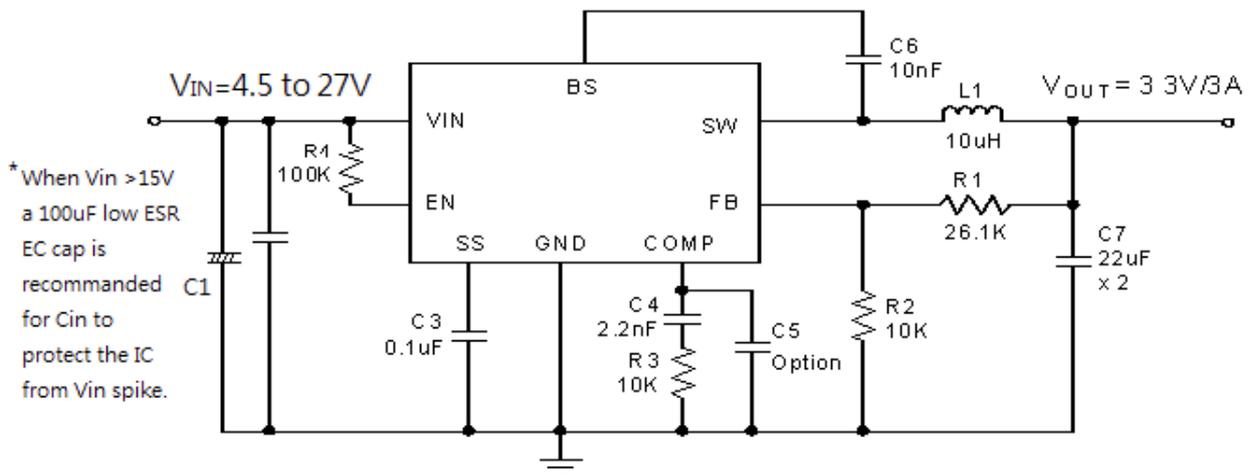


Package Information

- Applications**

- TFT LCD Monitors
- Portable DVDs, Headphones, MP3 Players, etc.
- Car-Powered or Battery-Powered Equipment
- Set-Top Boxes
- Telecom Power Supplies
- DSL and Cable Modems and Routers

- Typical Application**

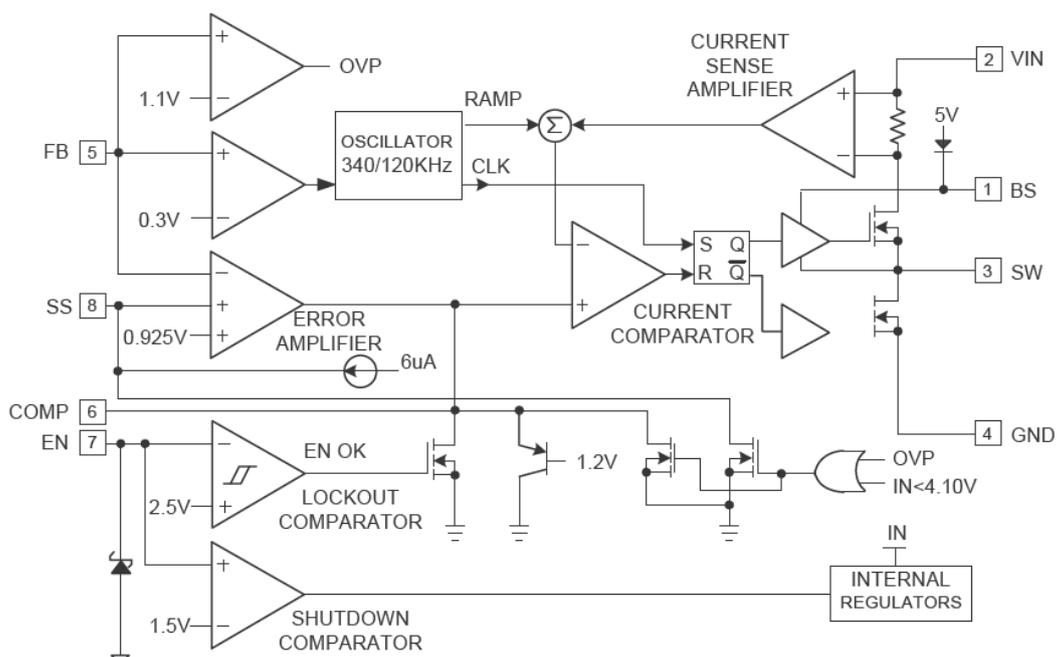


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● PIN DESCRIPTIONS

Pin Number	Name	Description
1	BS	Bootstrap. This pin acts as the positive rail for the high-side switch's gate driver. Connect a 0.01uF capacitor between BS and SW.
2	VIN	Input Supply. Bypass this pin to GND with a low ESR capacitor. See Input Capacitor in the Application Information section.
3	SW	Switch Output. Connect this pin to the switching end of the inductor.
4	GND	Ground.
5	FB	Feedback Input. The voltage at this pin is regulated to 0.925V. Connect to the resistor divider between output and ground to set output voltage.
6	COMP	Compensation Pin. See Stability Compensation in the Application Information section.
7	EN	Enable Input. When higher than 2.7V, this pin turns the IC on. When lower than 1.1V, this pin turns the IC off. Output voltage is discharged when the IC is off. This pin should not be left open. Recommend to put a 150KΩ pull-up resistor to Vin for startup.
8	SS	Soft-Start Control Input. SS controls the soft-start period. Connect a capacitor from SS to GND to set the soft-start period. A 0.1uF capacitor sets the soft-start period to 13ms. To disable the soft-start feature, leave SS unconnected.
	Exposed Pad	Exposed Pad. Need to connect to GND pin.

● Functional Block Diagram



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- **Absolute Maximum Ratings** @ $T_A=25^{\circ}\text{C}$ unless otherwise noted

Parameter	Value	Unit
Input Supply Voltage	-0.3 to 30	V
SW Voltage	-0.3 to $V_{IN} + 0.3$	V
BS Voltage	$V_{SW} - 0.3$ to $V_{SW} + 6$	V
EN, FB, COMP Voltage	-0.3 to 5	V
Continuous SW Current	Internally limited	A
Junction to Ambient Thermal Resistance (θ_{JA}) (Test on Approximately 3 in2 Copper Area 1oz copper FR4 board)	20	$^{\circ}\text{C}/\text{W}$
Junction to Ambient Case Resistance (θ_{JC})	10	$^{\circ}\text{C}/\text{W}$
SOP-8L Power Dissipation	Internally limited	W
Maximum Junction Temperature	150	$^{\circ}\text{C}$
Storage Temperature Range	-65 to 150	$^{\circ}\text{C}$
Moisture Sensitivity (MSL)	Please refer the MSL label on the IC package bag/carton for detail	

(Note: Exceeding these limits may damage the device. Even the duration of exceeding is very short. Exposure to absolute maximum rating conditions for long periods may affect device reliability.)

Recommended Operating Conditions

Parameter	Min	Max	Unit
Input Supply Voltage	4.5	27 ⁽¹⁾	V
Operating Junction Temperature	-20	+125 ⁽²⁾	$^{\circ}\text{C}$

(Note (1):

Operating the IC over this voltage is very easy to cause over voltage condition to V_{IN} pin, SW pin, BS pin & EN pin)

(Note (2):

If the IC experienced OTP, then the temperature may need to drop to $<125^{\circ}\text{C}$ to let the IC recover.)

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● **Electrical Characteristics @ $T_A=25^\circ\text{C}$ unless otherwise noted**

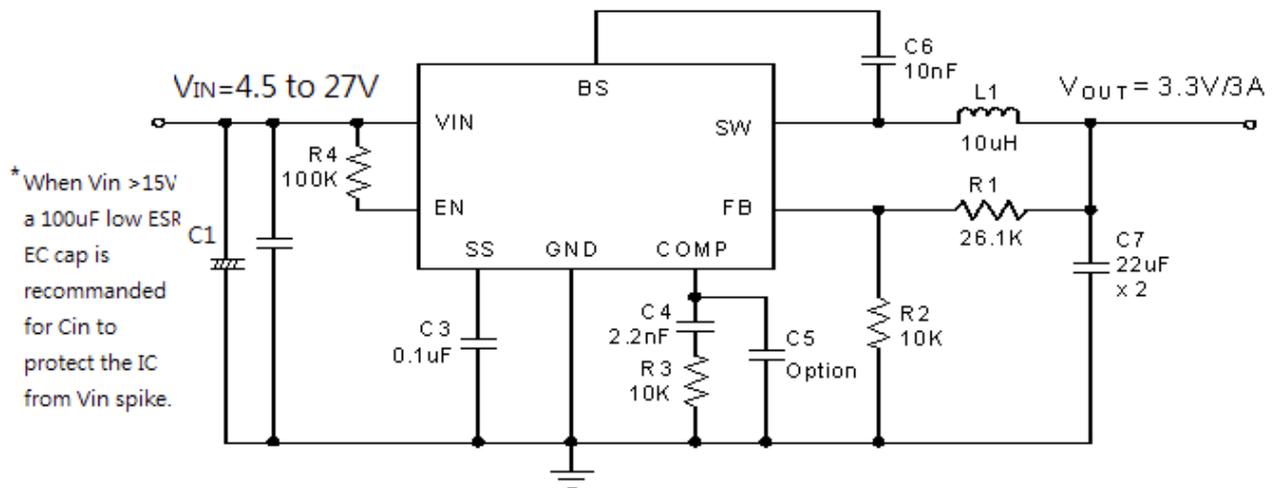
VIN = 12V, TA = +25°C, unless otherwise noted.

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Feedback Voltage	VFB	$4.5\text{V} \leq \text{VIN} \leq 27\text{V}$	0.900	0.925	0.950	V
Feedback Overvoltage Threshold				1.1		V
High-Side Switch-On Resistance*				90		mΩ
Low-Side Switch-On Resistance*				70		mΩ
High-Side Switch Leakage		VEN = 0V, VSW = 0V		0.1	10	μA
Upper Switch Current Limit*		Minimum Duty Cycle	3.8	4.5		A
Lower Switch Current Limit*		From Drain to Source		1.2		A
COMP to Current Sense Limit Transconductance	GCS			5.2		A/V
Error Amplifier Transconductance	GEA	$\Delta\text{ICOMP} = \pm 10\mu\text{A}$		900		μA/V
Error Amplifier DC Gain*	AVEA			400		V/V
Switching Frequency	fSW		300	340	380	KHz
Short Circuit Switching Frequency		VFB = 0		100		KHz
Minimum Duty Cycle*	Dmin		7.5			%
Maximum Duty Cycle	Dmax			92		%
EN Shutdown Threshold Voltage		VEN Rising	1.1	1.4	2	V
EN Shutdown Voltage Threshold Hysteresis				180		mV
EN Lockout Threshold Voltage			2.2	2.5	2.7	V
EN Lockout Hysteresis				150		mV
Supply Current in Shutdown		VEN = 0		0.3	3.0	μA
IC Supply Current in Operation		VEN = 3V, VFB = 1.0V		1.3	1.5	mA
Input UVLO Threshold Rising	UVLO	VEN Rising	3.80	4.0	4.40	V
Input UVLO Threshold Hysteresis				150		mV
Soft-start Current		VSS = 0V		6		μA
Soft-start Period		CSS = 0.1μF		13		mS
Thermal Shutdown Temperature*		Hysteresis = 25°C		155		°C

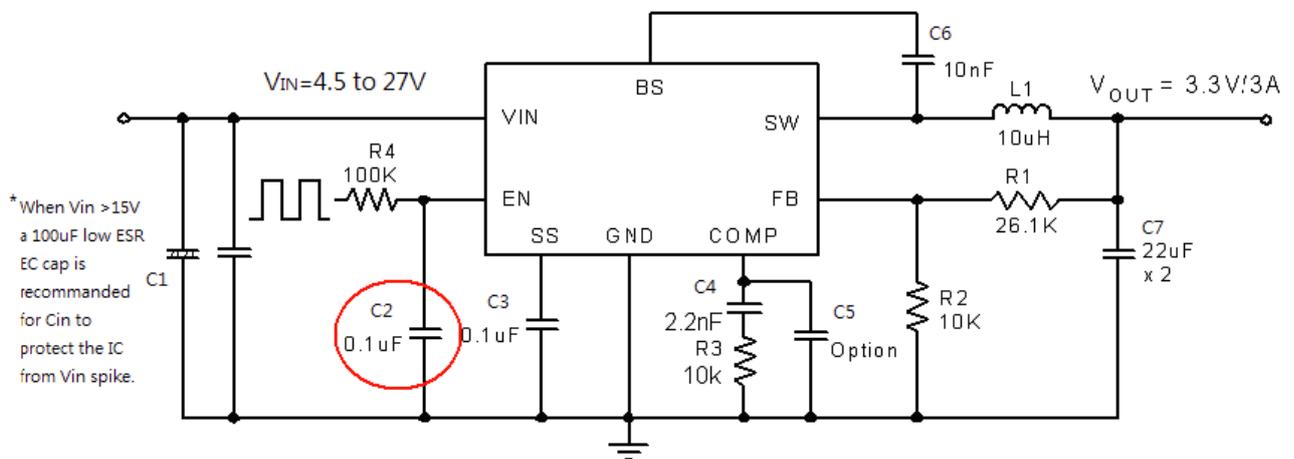
Note: * Guaranteed by design, not tested

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Application Description



FS1068E application circuit, 3.3V/3A output.



FS1068E application circuit, 3.3V/3A output with EN function

Note: **C2** is required for separate EN signal.

Output Voltage Setting

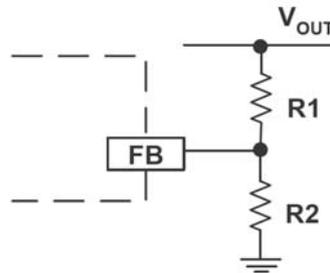


Figure1. Output Voltage Setting

Figure 1 shows the connections for setting the output voltage. Select the proper ratio of the two feedback resistors R1 and R2 based on the output voltage. Typically, use $R2 \approx 10\text{K}\Omega$ and determine R1 from the following equation:

$$R1 = R2 \left(\frac{V_{OUT}}{0.925V} - 1 \right)$$

VOUT	R1	R2
1.0V	1.0 K Ω	12 K Ω
1.2V	3.0 K Ω	10 K Ω
1.8V	9.53 K Ω	10 K Ω
2.5V	16.9 K Ω	10 K Ω
3.3V	26.1 K Ω	10 K Ω
5V	44.2 K Ω	10 K Ω
12V	121 K Ω	10 K Ω

Inductor Selection

The inductor maintains a continuous current to the output load. This inductor current has a ripple that is dependent on the inductance value: higher inductance reduces the peak-to-peak ripple current. The trade off for high inductance value is the increase in inductor core size and series resistance, and the reduction in current handling capability. In general, select an inductance value L based on the ripple current requirement:

$$L = \frac{V_{OUT} \cdot (V_{IN} - V_{OUT})}{V_{IN} f_{SW} I_{OUTMAX} K_{RIPPLE}} \quad (2)$$

where V_{IN} is the input voltage, V_{OUT} is the output voltage, f_{SW} is the switching frequency, I_{OUTMAX} is the maximum output current, and K_{RIPPLE} is the ripple factor. Typically, choose $K_{RIPPLE} = \sim 30\%$ to correspond to the peak-to-peak ripple current being $\sim 30\%$ of the maximum output current.

With this inductor value, the peak inductor current is $I_{OUT} \cdot (1 + K_{RIPPLE} / 2)$. Make sure that this peak inductor current is less than the upper switch current limit. Finally, select the inductor core size so that it does not saturate at the current limit. Typical inductor values for various output voltages are shown in Table 2.

VOUT	1.0V	1.2V	1.5V	1.8V	2.5V	3.3V	5V	9V
L	4.7uH	4.7uH	10uH	10uH	10uH	10uH	10uH	22uH

Table 2. Typical Inductor Values

Input Capacitor

The input capacitor needs to be carefully selected to maintain sufficiently low ripple at the supply input of the converter. A low ESR **Electrolytic (EC) capacitor** is highly recommended. Since large current flows in and out of this capacitor during switching, its ESR also affects efficiency.

When EC cap is used, the input capacitance needs to be equal to or higher than 100uF. The RMS ripple current rating needs to be higher than 50% of the output current. The input capacitor should be placed close to the VIN and GND pins of the IC, with the shortest traces possible. The input capacitor can be placed a little bit away if a small parallel 0.1uF ceramic capacitor is placed right next to the IC.

When Vin is >15V, pure ceramic Cin (* no EC cap) is not recommended.

This is because the

ESR of a ceramic cap is often too small, Pure ceramic Cin will work with the parasite inductance of the input trace and forms a Vin resonant tank. When Vin is hot plug in/out, this resonant tank will boost the Vin spike to a very high voltage and damage the IC.

Output Capacitor

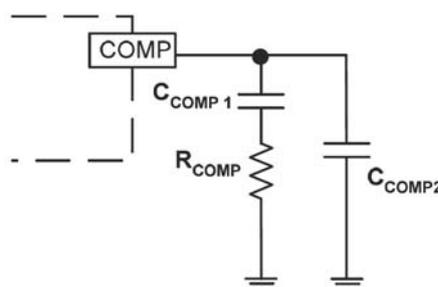
The output capacitor also needs to have low ESR to keep low output voltage ripple. In the case of ceramic output capacitors, R_{ESR} is very small and does not contribute to the ripple. Therefore, a lower capacitance value can be used for ceramic capacitors. In the case of tantalum or electrolytic capacitors, the ripple is dominated by R_{ESR} multiplied by the ripple current. In that case, the output capacitor is chosen to have sufficiently low ESR.

For ceramic output capacitors, typically choose two capacitors of about 22uF. For tantalum or electrolytic capacitors, choose a capacitor with less than 50m

Optional Schottky Diode

During the transition between high-side switch and low-side switch, the body diode of the low side power MOSFET conducts the inductor current. The forward voltage of this body diode is high. An optional Schottky diode may be paralleled between the SW pin and GND pin to improve overall efficiency.

Stability Compensation



C_{COMP2} is needed only for high ESR output capacitor

Figure 2. Stability Compensation

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The feedback loop of the IC is stabilized by the components at the COMP pin, as shown in Figure 2. Though C_{COMP2} is unnecessary when the output capacitor has sufficiently low ESR, a small value C_{COMP2} such as 100pF may improve stability against PCB layout parasitic effects.

Vin Range (V)	Vout, (V)	Cout	Rcomp, (k Ω)	Ccomp, (nF)	Ccomp2, (pF)	Inductor, (uH)
5 – 12	1.0	22uF x2 Ceramic	2.4	6.8	none	4.7
5 – 15	1.2		3	6.2	none	4.7
5 – 15	1.8		6.2	3	none	10
5 – 15	2.5		8	2.2	none	10
5 – 15	3.3		10	2.2	none	10
7 – 15	5		10	2.2	none	10
5 – 12	1.0	470uF/ 6.3V/ 120m Ω	10	10	680	10
1.2						
1.8						
2.5						
3.3						
5						

Table 4 Component Selection Guide for Stability Compensation